

Docket No.: JCLA24132

Form 1595 (Rev. 09/04)

RECORDATION FORM COVER SHEET

U. S. Department of Commerce
Patent and Trademark Office

PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below

1. Name of conveying party(ies) with the
execution date:

PAO-NAN LEE, July 15, 2008

CHI-TSUNG CHIU, July 15, 2008

2. Name/address of receiving Party(ies)

ADVANCED SEMICONDUCTOR
ENGINEERING, INC.26, CHIN 3RD. RD., 811, NANTZE EXPORT
PROCESSING ZONE, KAOHSIUNG, TAIWAN,
R.O.C.

3. Nature of conveyance:

- ☒ Assignment ☐ Security Agreement
☐ Merger ☐ Change of Name
☐ Reassignment ☐ Other

Add'l names of receiving parties
Attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

A. Patent Application No. (s)

12/175,720

Additional number attached?

B. Patent No.(s)

☐ Yes ☒ No5. Name and address of party to whom
correspondence concerning document
should be mailed:J. C. Patents
4 Venture, Suite 250
Irvine, CA 92618
(949) 660-07616. Total No. of applications and patents
involved:

ONE (1)

7. Total fee(37CFR§3.41): \$ 40.00

- ☐ Authorized to be charged by credit card
☒ Authorized to be charge to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

- a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number 50-0710
Authorized User Name Jiawei Huang

Atty Docket No.: JCLA24132

9. Statement and Signature:

To the best of my knowledge and belief, the forging information is true and
Correct and any attached copy is a true copy of the original document.

Jiawei Huang

Name of person Signing
Registration No. 43,330


Signature

7-18-2008

Date

Total number of pages
including cover sheet,
attachments, and
documents: 3

CH \$40.00 500710 12175720

700378569

PATENT
REEL: 021261 FRAME: 0814

ASEK1962
24132-US-PA

ASSIGNMENT

WHEREAS,

1. Lee, Pao-Nan

2. Chiu, Chi-Tsung

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **CIRCUIT SUBSTRATE AND METHOD FOR FABRICATING INDUCTIVE CIRCUIT**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, Advanced Semiconductor Engineering, Inc.
of 26, Chin 3rd. Rd., 811, Nantze Export Processing Zone, Kaohsiung, Taiwan,
R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Pao-Nan, Lee

Date: July 15, 2008

Sole or First Joint Inventor: Lee, Pao-Nan

Signature: Chi Tsung Chiu

Date: July 15, 2008

Second Joint Inventor (if any): Chiu, Chi-Tsung

J.C. PATENTS
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CERTIFICATE OF TRANSMISSION

July 18, 2008

Atty Docket No.	:	JCLA24132
Appl. No.	:	12/175,720
Filing Date	:	July, 18, 2008
Pages	:	Cover + 3

BY FACSIMILE ONLY

Fax No.	:	571-273-0140
Attention	:	MAIL STOP Assignment Commissioner for Patents
From	:	Jiawei Huang, Reg. No. 43,330
MESSAGE	:	Enclosed herewith is a Recordation Cover Sheet with Assignment in 3 pages.

Sir:

I hereby certify that this correspondence is being facsimile transmitted to the Patent and
Trademark Office on **July 18, 2008** at the above indicated fax number.

Sign by: 

Michelle Chang

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